

Aluminum Electrolytic Capacitors

SMD (Chip), High Temperature, Low Impedance, High Vibration Capability

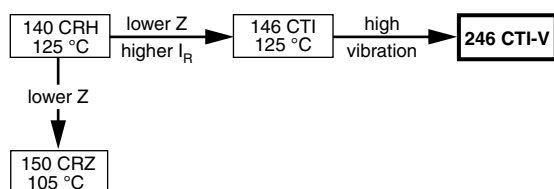


Fig. 1

QUICK REFERENCE DATA	
DESCRIPTION	VALUE
Nominal case sizes (L x W x H in mm)	16 x 16 x 16 to 18 x 18 x 21
Rated capacitance range, C _R	150 µF to 4700 µF
Tolerance on C _R	± 20 %
Rated voltage range, U _R	16 V to 100 V
Category temperature range	-55 °C to +125 °C
Endurance test at 125 °C	2000 h to 5000 h
Useful life at 125 °C	2500 h to 6000 h
Useful life at 40 °C 1.8 x I _R applied	350 000 h to 400 000 h
Shelf life at 0 V, 125 °C	1000 h
Based on sectional specification	IEC 60384-18 / CECC 32300
Climatic category IEC 60068	55 / 125 / 56

FEATURES

- Extended useful life: up to 6000 h at 125 °C
- Polarized aluminum electrolytic capacitors, non-solid electrolyte, self healing
- SMD-version with base plate, lead (Pb)-free reflow solderable
- Charge and discharge proof, no peak current limitation
- Advanced temperature reflow soldering according to JEDEC® J-STD-020
- Vibration proof, 6-pin version up to 30 g
- AEC-Q200 qualified
- High reliability
- Low ESR
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE
GRADE

RoHS
COMPLIANT

APPLICATIONS

- SMD technology, for high temperature reflow soldering
- Industrial and professional applications
- Automotive, general industrial, telecom
- Smoothing, filtering, buffering

MARKING

- Rated capacitance (in µF)
- Rated voltage (in V)
- Date code, in accordance with IEC 60062
- Black mark or “-” sign indicating the cathode (the anode is identified by beveled edges)
- Code indicating group number (T)

PACKAGING

Supplied in blister tape on reel

SELECTION CHART FOR C_R, U_R, AND RELEVANT NOMINAL CASE SIZES (L x W x H in mm)							
C_R (μF)	U_R (V)						
	16	25	35	50	63	80	100
150	→	→	→	→	→	→	16 x 16 x 16
220	→	→	→	→	→	16 x 16 x 16	16 x 16 x 21
							18 x 18 x 16
330	→	→	→	→	16 x 16 x 16	16 x 16 x 21	18 x 18 x 21
						18 x 18 x 16	
470	→	→	→	16 x 16 x 16	16 x 16 x 16	18 x 18 x 21	-
680	→	→	16 x 16 x 16	16 x 16 x 16	18 x 18 x 16	-	-
820	→	→	→	→	16 x 16 x 21	-	-
1000	→	16 x 16 x 16	16 x 16 x 16	16 x 16 x 21	18 x 18 x 21	-	-
				18 x 18 x 16			
1200	→	→	18 x 18 x 16	18 x 18 x 21	-	-	-
1500	16 x 16 x 16	16 x 16 x 16	16 x 16 x 21	-	-	-	-
1800	→	→	18 x 18 x 21	-	-	-	-
2200	16 x 16 x 16	16 x 16 x 21	-	-	-	-	-
		18 x 18 x 16					
2700	→	18 x 18 x 21	-	-	-	-	-
3300	16 x 16 x 21	-	-	-	-	-	-
	18 x 18 x 16						
3900	18 x 18 x 21	-	-	-	-	-	-
4700	18 x 18 x 21	-	-	-	-	-	-

6-pin:
≥ Ø 16 mm

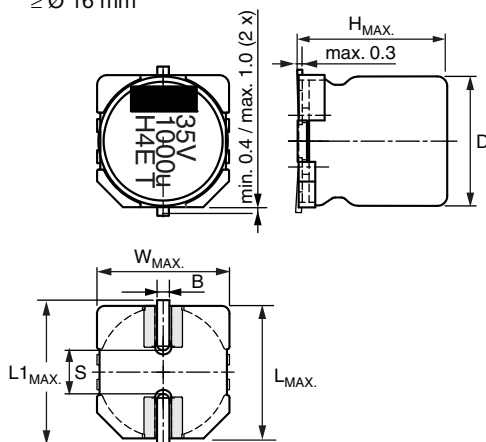


Fig. 1 - Dimensional outline

Table 1

DIMENSIONS in millimeters AND MASS									
NOMINAL CASE SIZE L x W x H	CASE CODE	L _{MAX.}	W _{MAX.}	H _{MAX.}	Ø D	B _{MAX.}	S	L1 _{MAX.}	MASS (g)
16 x 16 x 16	1616	16.6	16.6	17.5	16.0	1.3	6.5	18.6	≈ 5.5
16 x 16 x 21	1621	16.6	16.6	22.0	16.0	1.3	6.5	18.6	≈ 6.0
18 x 18 x 16	1816	19.0	19.0	17.5	18.0	1.3	6.5	21.0	≈ 8.0
18 x 18 x 21	1821	19.0	19.0	22.0	18.0	1.3	6.5	21.0	≈ 8.3

Table 2

TAPE AND REEL DIMENSIONS in millimeters, PACKAGING QUANTITIES						
NOMINAL CASE SIZE L x W x H	CASE CODE	PITCH P ₁	TAPE WIDTH W	TAPE THICKNESS T ₂	REEL DIAMETER	PACKAGING QUANTITY PER REEL
16 x 16 x 16	1616	28	44	18.9	380	150
16 x 16 x 21	1621	28	44	23.4	380	100
18 x 18 x 16	1816	32	44	18.9	380	125
18 x 18 x 21	1821	32	44	23.4	380	100

Note

- Detailed tape dimensions see section “PACKAGING”

MOUNTING

The capacitors are designed for automatic placement on to printed-circuit boards.

Optimum dimensions of soldering pads depend amongst others on soldering method, mounting accuracy, print layout and / or adjacent components.

For recommended soldering pad dimensions, refer to Fig. 3 and Table 3.

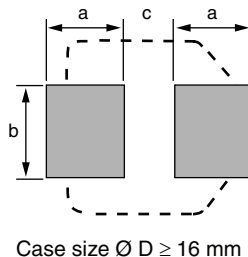
SOLDERING

Soldering conditions are defined by the curve, temperature versus time, where the temperature is that measured on the component during processing.

For maximum conditions refer to Fig. 4.

Any temperature versus time curve which does not exceed the specified maximum curves may be applied.

As a general principle, temperature and duration shall be the **minimum** necessary required to ensure good soldering connections. However, the specified maximum curves should never be exceeded.


Fig. 2 - Recommended soldering pad dimensions
Table 3

RECOMMENDED SOLDERING PAD DIMENSIONS in millimeters			
CASE CODE	a	b	c
1616	7.8	9.6	4.7
1621	7.8	9.6	4.7
1816	8.8	9.6	4.7
1821	8.8	9.6	4.7

ADVANCED SOLDERING PROFILE FOR LEAD (Pb)-FREE REFLOW PROCESS ACCORDING TO JEDEC J-STD-020

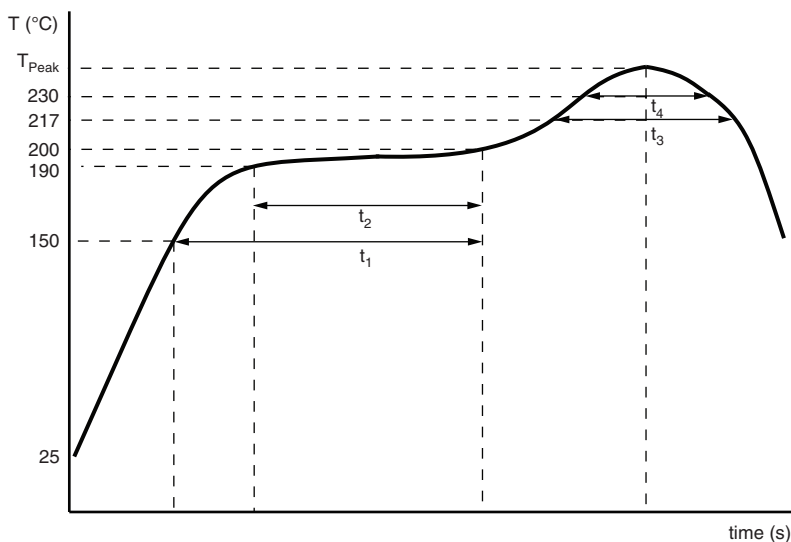


Fig. 3 - Maximum temperature load during reflow soldering

Table 4

REFLOW SOLDERING CONDITIONS for MAL224699xxxE3	
PROFILE FEATURES	CASE CODE 1616 TO 1821
Maximum time from 25 °C to T_{Peak}	300 s
Maximum ramp-up rate to 150 °C	3 K/s
Maximum time from 150 °C to 200 °C (t_1)	150 s
Maximum time from 190 °C to 200 °C (t_2)	110 s
Ramp up rate from 200 °C to T_{Peak}	0.5 K/s to 3 K/s
Maximum time above $T_{Liquidus}$ (217 °C) (t_3)	90 s
Maximum time above 230 °C (t_4)	60 s
Peak temperature T_{Peak}	245 °C
Maximum time above T_{Peak} minus 5 °C	30 s
Ramp-down rate from $T_{Liquidus}$	3 K/s to 6 K/s

Notes

- Temperature measuring point on top of the case and on terminals
- Maximum 2 runs with pause of minimum 30 min in between



ELECTRICAL DATA	
SYMBOL	DESCRIPTION
C_R	Rated capacitance at 100 Hz, tolerance $\pm 20\%$
I_R	Rated RMS ripple current at 100 kHz, 125 °C
I_{L2}	Maximum leakage current after 2 min at U_R
$\tan \delta$	Maximum dissipation factor at 100 Hz
Z	Maximum impedance at 100 kHz

Note

- Unless otherwise specified, all electrical values in Table 5 apply at $T_{amb} = 20\text{ °C}$, $P = 86\text{ kPa}$ to 106 kPa , $RH = 45\%$ to 75%

Table 5

ELECTRICAL DATA AND ORDERING INFORMATION									
U_R (V)	C_R (μF)	NOMINAL CASE SIZE L x W x H (mm)	I_R 125 °C 100 kHz (mA)	I_{L2} 2 min (μA)	$\tan \delta$ 100 Hz	Z 100 kHz 20 °C (Ω)	Z 100 kHz -40 °C (Ω)	LIFE CODE ⁽¹⁾	ORDERING CODE MAL2246...
16	1500	16 x 16 x 16	1400	240	0.16	0.050	0.45	L2	99505E3
	2200	16 x 16 x 16	1400	352	0.18	0.050	0.45	L2	99506E3
	3300	16 x 16 x 21	1660	528	0.20	0.035	0.32	L3	99507E3
	3300	18 x 18 x 16	1500	528	0.20	0.050	0.45	L2	99508E3
	3900	18 x 18 x 21	1750	624	0.20	0.035	0.32	L3	99509E3
	4700	18 x 18 x 21	1750	752	0.22	0.035	0.32	L3	99511E3
25	1000	16 x 16 x 16	1400	250	0.14	0.050	0.45	L2	99605E3
	1500	16 x 16 x 16	1400	375	0.14	0.050	0.45	L2	99606E3
	2200	16 x 16 x 21	1660	550	0.16	0.035	0.32	L3	99607E3
	2200	18 x 18 x 16	1500	550	0.16	0.050	0.45	L2	99608E3
	2700	18 x 18 x 21	1750	675	0.16	0.035	0.32	L3	99609E3
35	680	16 x 16 x 16	1400	238	0.12	0.050	0.45	L2	99007E3
	1000	16 x 16 x 16	1400	350	0.12	0.050	0.45	L2	99008E3
	1200	18 x 18 x 16	1500	420	0.12	0.050	0.45	L2	99009E3
	1500	16 x 16 x 21	1660	525	0.12	0.035	0.32	L3	99011E3
	1800	18 x 18 x 21	1750	630	0.12	0.035	0.32	L3	99012E3
50	470	16 x 16 x 16	1300	235	0.10	0.072	0.65	L2	99108E3
	680	16 x 16 x 16	1300	340	0.10	0.072	0.65	L2	99109E3
	1000	16 x 16 x 21	1500	500	0.10	0.052	0.47	L3	99111E3
	1000	18 x 18 x 16	1300	500	0.10	0.070	0.63	L2	99112E3
	1200	18 x 18 x 21	1600	600	0.10	0.049	0.44	L3	99113E3
63	330	16 x 16 x 16	1050	208	0.10	0.100	0.90	L2	99809E3
	470	16 x 16 x 16	1050	296	0.10	0.100	0.90	L2	99811E3
	680	18 x 18 x 16	1150	428	0.10	0.095	0.86	L2	99812E3
	820	16 x 16 x 21	1300	517	0.10	0.075	0.68	L3	99813E3
	1000	18 x 18 x 21	1400	630	0.10	0.072	0.65	L3	99814E3
80	220	16 x 16 x 16	900	176	0.12	0.180	1.44	L1	99708E3
	330	16 x 16 x 21	1100	264	0.12	0.120	0.96	L1	99709E3
	330	18 x 18 x 16	900	264	0.12	0.160	1.28	L1	99711E3
	470	18 x 18 x 21	1100	376	0.12	0.110	0.88	L1	99712E3
100	150	16 x 16 x 16	650	150	0.12	0.300	2.40	L1	99907E3
	220	16 x 16 x 21	810	220	0.12	0.230	1.80	L1	99908E3
	220	18 x 18 x 16	650	220	0.12	0.300	2.40	L1	99909E3
	330	18 x 18 x 21	810	330	0.12	0.230	1.80	L1	99911E3

Note

- ⁽¹⁾ Determines the applicable row in the table "Endurance Test Duration and Useful Life"

Table 6

EXTENDED VIBRATION SPECIFICATIONS		
PARAMETER	PROCEDURE	REQUIREMENTS
Vibration improvement	From 10 g to 30 g	No visible damage; no leakage of electrolyte; marking legible $\Delta C/C$: $\pm 5\%$ with respect to initial measurements
Vibration frequency range	10 Hz to 2 kHz	
Vibration profile	- Constant sinus sweep 3 directions 8 h per direction	

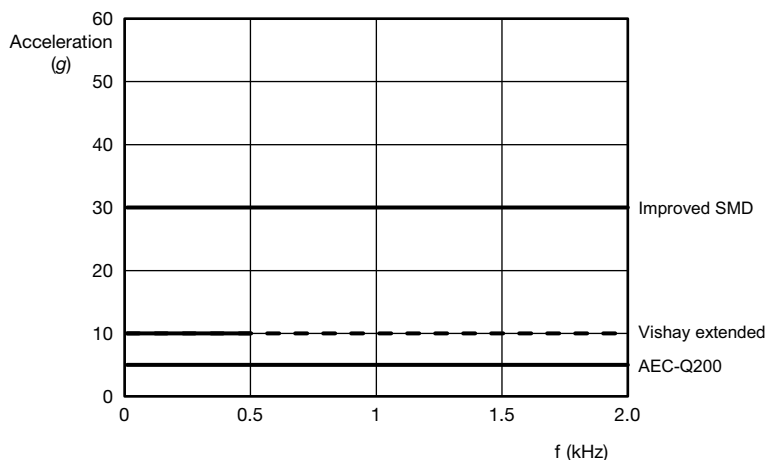


Fig. 4 - Vibration profile

Table 7

ADDITIONAL ELECTRICAL DATA		
PARAMETER	CONDITIONS	VALUE
Voltage		
Surge voltage for short periods	IEC 60384-18, subclause 4.14	$U_S \leq 1.15 \times U_R$
Reverse voltage for short periods	IEC 60384-18, subclause 4.16; $T_A \leq 105^\circ\text{C}$	$U_{rev} \leq 1\text{ V}$
Current		
Leakage current	After 2 min at U_R	$I_{L2} \leq 0.01 \times C_R \times U_R$
Inductance		
Equivalent series inductance (ESL)	$\varnothing D \geq 16\text{ mm}$	Typ. 11 nH
Resistance		
Equivalent series resistance (ESR) at 100 Hz	Calculated from $\tan \delta_{max}$ and C_R (see Table 5)	$ESR = \tan \delta / 2\pi f C_R$

CAPACITANCE (C)

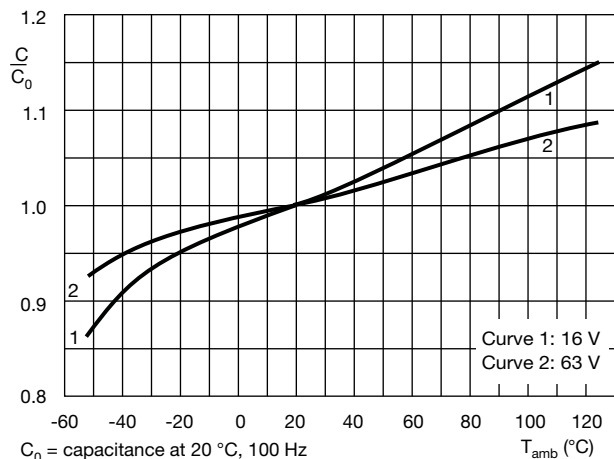
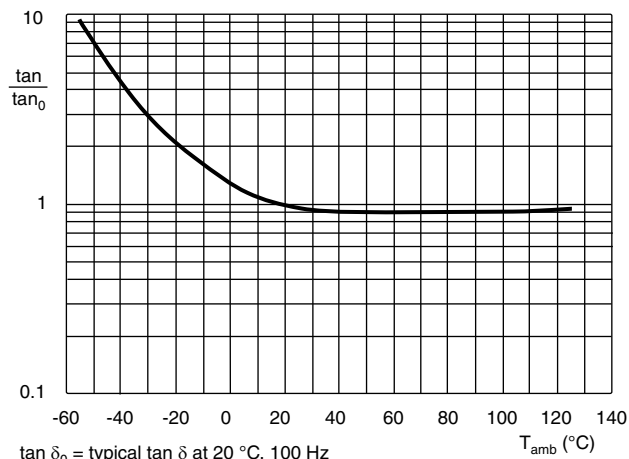


Fig. 5 - Typical multiplier of capacitance as a function of ambient temperature

DISSIPATION FACTOR ($\tan \delta$)


Fig. 6 - Typical multiplier of dissipation factor ($\tan \delta$) as a function of ambient temperature

EQUIVALENT SERIES RESISTANCE (ESR)

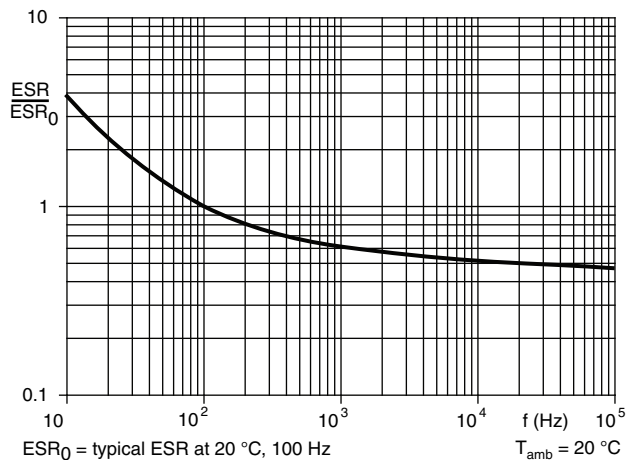


Fig. 7 - Typical multiplier of ESR as a function of frequency

IMPEDANCE (Z)

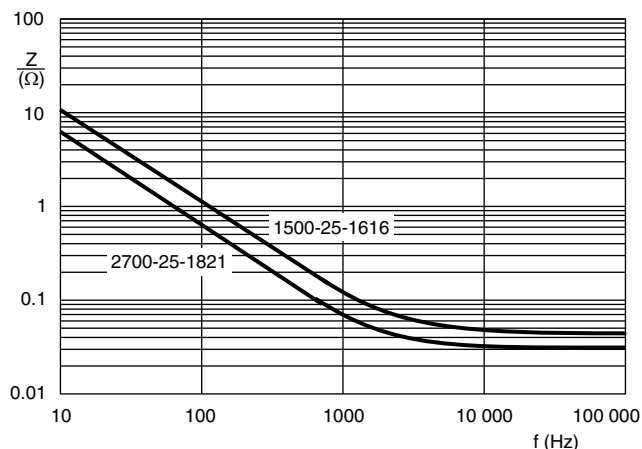


Fig. 8 - Typical impedance as a function of frequency

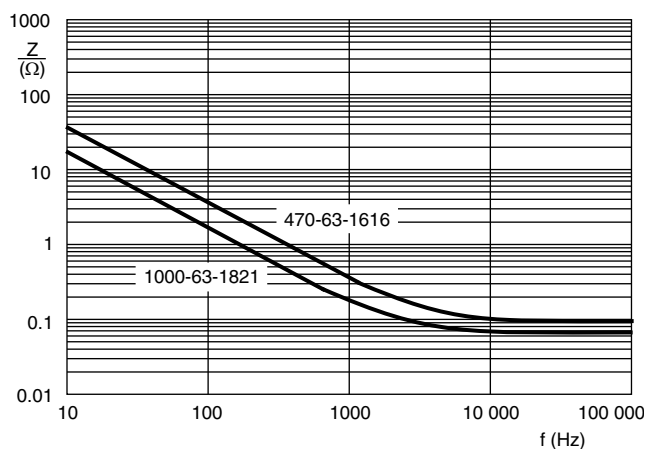


Fig. 9 - Typical impedance as a function of frequency

IMPEDANCE (Z)

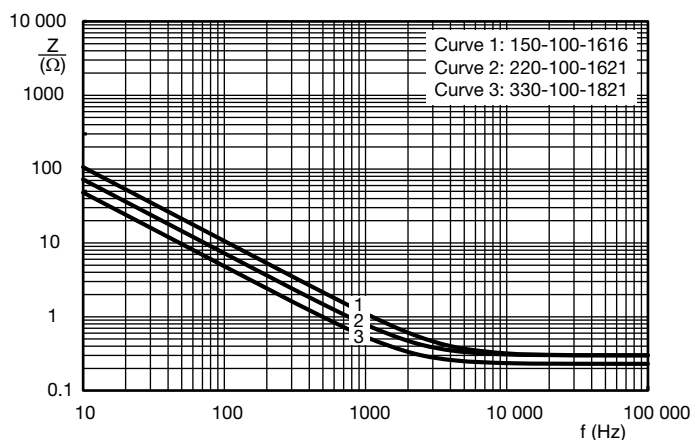


Fig. 10 - Typical impedance as a function of frequency

RIPPLE CURRENT AND USEFUL LIFE

Table 8

ENDURANCE TEST DURATION AND USEFUL LIFE			
LIFE CODE	ENDURANCE AT 125 °C (h)	USEFUL LIFE AT 125 °C (h)	USEFUL LIFE AT 40 °C 1.8 x I _R APPLIED (h)
L1	2000	2500	250 000
L2	4000	5000	350 000
L3	5000	6000	400 000

Note

- Multiplier of useful life code: MBC242

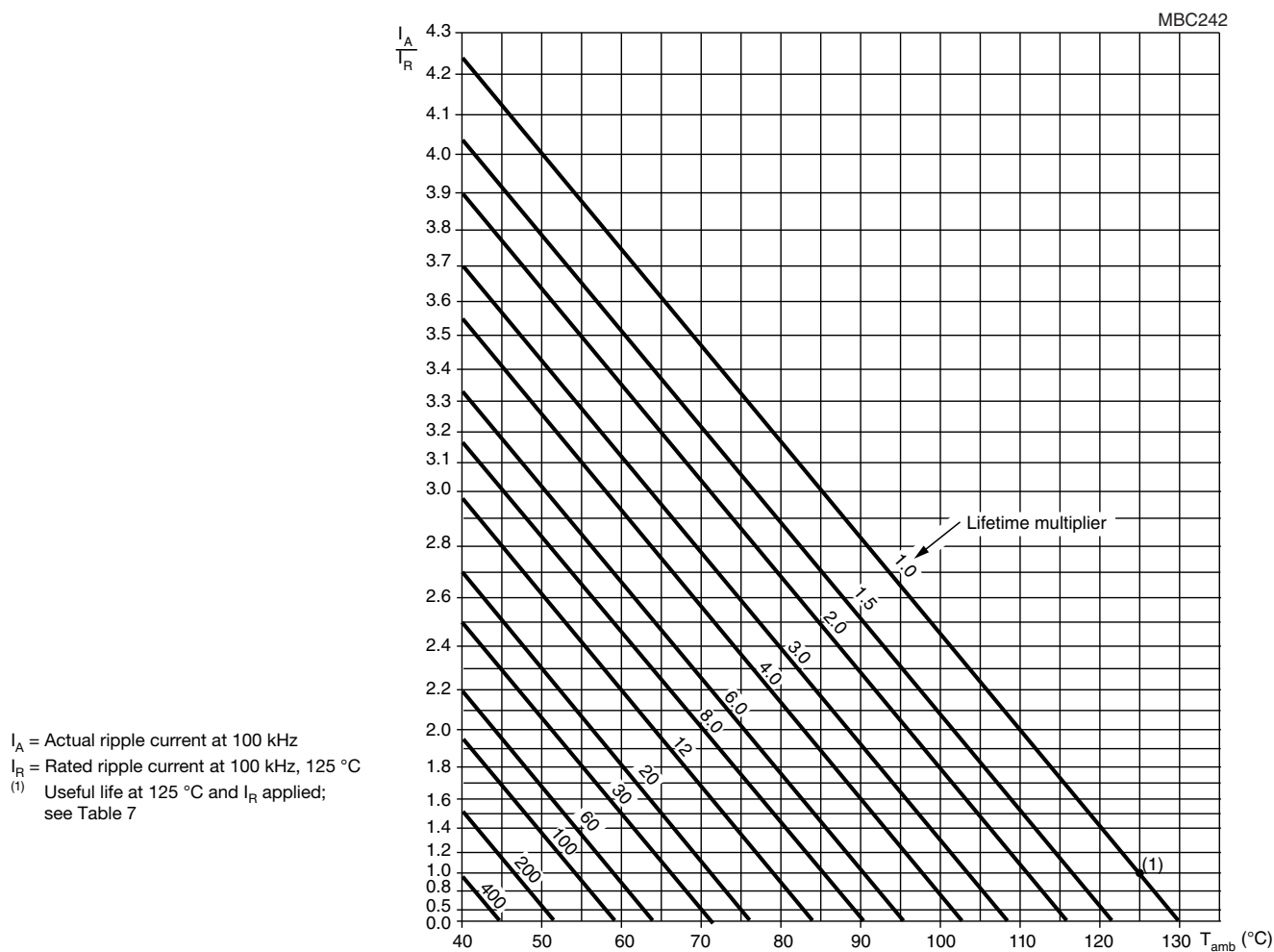


Fig. 11 - Multiplier of useful life as a function of ambient temperature and ripple current load

Table 9

MULTIPLIER OF RIPPLE CURRENT (I_R) AS A FUNCTION OF FREQUENCY								
U_R (V)	FREQUENCY (Hz)							
	50	100	300	1000	3000	10 000	30 000	100 000
16	0.60	0.70	0.80	0.85	0.90	0.95	0.97	1.00
25	0.60	0.70	0.80	0.85	0.90	0.95	0.97	1.00
35	0.45	0.65	0.80	0.85	0.90	0.95	0.97	1.00
50	0.40	0.60	0.75	0.82	0.90	0.95	0.97	1.00
63	0.40	0.60	0.75	0.82	0.90	0.95	0.97	1.00
80	0.40	0.60	0.75	0.82	0.90	0.95	0.97	1.00
100	0.40	0.60	0.75	0.82	0.90	0.95	0.97	1.00

Table 10

TEST PROCEDURES AND REQUIREMENTS			
TEST		PROCEDURE (quick reference)	REQUIREMENTS
NAME OF TEST	REFERENCE		
Mounting	IEC 60384-18, subclause 4.3	Shall be performed prior to tests mentioned below; reflow soldering; for maximum temperature load refer to chapter "Mounting"	$\Delta C/C: \pm 5 \%$ $\tan \delta \leq \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$
Endurance	IEC 60384-18 / CECC 32300, subclause 4.15	$T_{\text{amb}} = 125 \text{ }^\circ\text{C}$; U_R applied; for test duration see Table 7	$U_R \geq 16 \text{ V}$; $\Delta C/C: \pm 20 \%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$
Useful life	CECC 30301, subclause 1.8.1	$T_{\text{amb}} = 125 \text{ }^\circ\text{C}$; U_R and I_R applied; for test duration see Table 7	$\Delta C/C: \pm 30 \%$ $\tan \delta \leq 3 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ no short or open circuit total failure percentage: $\leq 1 \%$
Shelf life (storage at high temperature)	IEC 60384-18 / CECC 32300, subclause 4.17	$T_{\text{amb}} = 125 \text{ }^\circ\text{C}$; no voltage applied; 1000 h after test: U_R to be applied for 30 min, 24 h to 48 h before measurement	For requirements see "Endurance test" above
Reverse voltage	IEC 60384-18 / CECC 32300, subclause 4.16	$T_{\text{amb}} = 125 \text{ }^\circ\text{C}$: 125 h at $U = -0.5 \text{ V}$, followed by 125 h at U_R	$\Delta C/C: \pm 15 \%$ $\tan \delta \leq 1.5 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$

Statements about product lifetime are based on calculations and internal testing. They should only be interpreted as estimations. Also due to external factors, the lifetime in the field application may deviate from the calculated lifetime. In general, nothing stated herein shall be construed as a guarantee of durability.



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На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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